

"Nighthawk" IMSE® demonstrator

Enabling smart surface design with high-performance materials





initis.

The Nighthawk demonstrator is the result of a collaboration between Covestro and TactoTek, leveraging IMSE® (In-Mold Structural Electronics) technology and high-performance materials. IMSE® parts offer numerous advantages over traditional electro-mechanical assemblies. By achieving electronics functionality, esthetics, and structure in a single part, IMSE® maximizes resource efficiency, design flexibility, and reliability.



Sandwich structure of IMSE® part

The IMSE® manufacturing process



- 1. Film printing decoration applied to A film, silver ink applied to B film
- 2. Component mounting LEDs and other
 - components mounted to B film





Any surface becomes a smart surface

The Nighthawk demonstrator illustrates the next-generation design of functionalized and seamless smart surfaces. Using state-of-the-art polycarbonate (PC) materials from Covestro, harmonized with TactoTek's advanced approach to electronics integration, the Nighthawk demonstrator highlights how any device can be:

Thinner & Lighter

- Electronics embedded in structure
- 90% space reduction
- 50% weight reduction
- Efficient use of plastics

Infinitely Customizable

- State-of-the-art materials enable infinite surface functions
- Maximum design freedom (e.g. color, finish, geometry)

Reliable & Sustainable

- Reduced modes of failure through component encapsulation
- Reduces CO₂ emissions up to 60%, cradle to gate
- Easily upgraded through software updates

Cost-Effective

- Reduced value chain complexity
- · Cost-effective versus traditional HMI manufacturing
- Reduces SKUs for multiple models

At Covestro, creating a brighter future means embracing full circularity to achieve 100% climate neutrality by 2035. Our circularity initiatives leverage alternative energy and raw material sources, and extend polymer life cycles through advanced recycling initiatives.

IMSE® technology unlocks the future of sustainable electronics by generating applications with

- Greater material efficiency: Reducing size and weight generates applications that require less material.
- Longer lifespan: IMSE® applications are mono-material solutions, very reliable, and easy to upgrade and recycle.
- Reduced production complexity: IMSE[®] simplifies traditional manufacturing tooling while also reducing waste.

At the forefront of innovation and sustainability, Covestro launched the world's first carbon-neutral polycarbonate in 2021. By replacing fossil-based materials with biomass materials, Makrolon® RE polycarbonate offers the same high-quality performance with net-zero carbon footprint. Makrofol® PC films partly made from biomass materials further contribute to reducing CO₂.



IMSE[®] and reference global warming potentials, in kg CO₂-eq.

Life cycle stages stacked. Functional unit: one piece of car control panel

Silver in conductive inks and adhesives

Manufacturing



Material production

Electronics



"Covestro materials, Makrolon® for polycarbonates, Makrofol® for polycarbonate films, are instrumental in the structural integrity and performance of those parts in demanding industries like automotive and high-end electronics."

– Dave Rice, SVP, Marketing and Business Development TactoTek





Solutions for a more circular, climate-neutral world



Find out about our more sustainable materials and how they can contribute to a circular economy.

Circular Economy | Covestro AG

Makrolon® RE - the more sustainable and renewable future of polycarbonates



Discover the circular and more sustainable RE product series as part of the circular intelligent product solutions from Covestro.

<u>Circular polycarbonates for a reduced carbon footprint</u> with a high renewable share | Covestro AG



Covestro Deutschland AG

Kaiser-Wilhelm-Allee 60 51373 Leverkusen Germanv

solutions.covestro.com films.covestro.com films@covestro.com

plastics.covestro.com plastics@covestro.com The manner in which you use our products, technical assistance and information (whether verbal, written or by way of production evaluations), including any suggested formulations and recommendations, is processing and intended uses. Your analysis must at least include testing to determine suitability from a technical, health, safety, and environmental and regulatory standpoint. Such testing has not necessarily been done by Covestro, and Covestro has not obtained any approvals or licenses for a particular use or application of the product, unless explicitly stated otherwise. [EMEA only: If the intended use of the products for medical devices or for other specifically regulated applications which lead or may lead to a regulatory obligation of Covestro, Covestro must explicitly agree to such application before the sale.] Any samples provided by Covestro are for testing purposes only and not for commercial use. Unless we otherwise agree in writing, all products are sold strictly pursuant to the terms of our standard conditions of sale which are available upon request. All information, including technical assistance is given without warranty or guarantee and is subject to change without notice. It is expressly understood and agreed by you that you assume and hereby expressly release and indemnify us and hold us harmless from all liability, in tort, contract or otherwise, incurred in connection with the use of our products, technical assistance, and information. Any statement or recommendation not contained herein is unauthorized and shall not bind us. Nothing herein shall be construed as a recommendation to use any product in conflict with any claim of any patent relative to any material or its use. No license is implied or in fact granted under the claims of any patent. These values are typical values only. Unless explicitly agreed in written form, they do not constitute a binding material specification or warranted values

¹Please see the "Guidance on Use of Covestro Products in a Medical Application" document.

TactoTek® and IMSE® are registered trademarks of TactoTek.

©2023 Covestro Deutschland AG